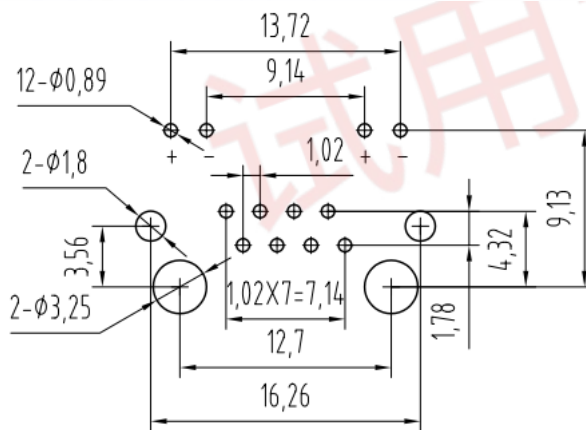
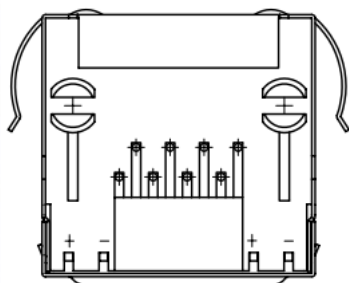
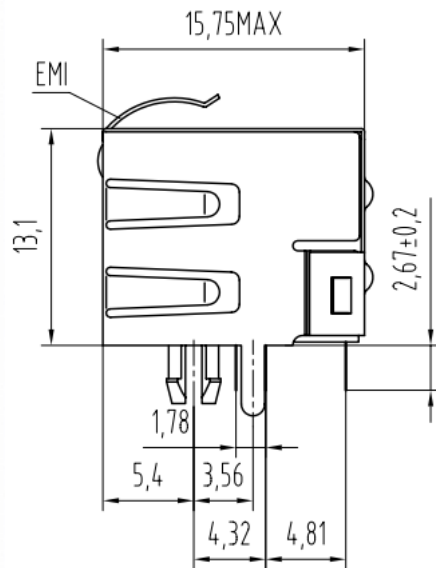
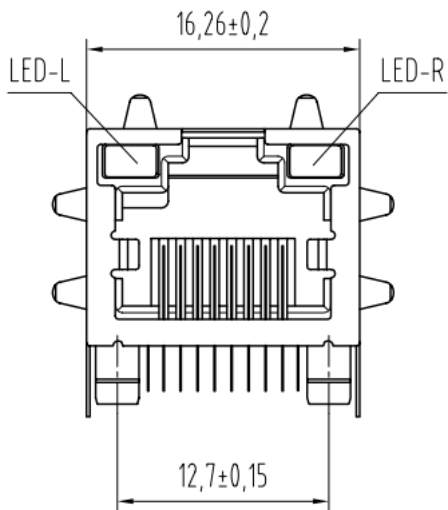




PC Board Layout
Component Side Shown

NOTES:

MATERIAL :

- 1.HOUSING MATERIAL :GLASS FILLED POLYESTER UL94V-0.
- 2.CONTACT MATERIAL :PHOSPHOR BRONZE $\phi 0.46\text{mm}$.
- 3.PLATING :GOLD PLATING OVER NICKEL.
- 4.SHIELD :0.23mm THICKNESS COPPER ALLOY WITH NICKEL PLATED.
- 5.LED :OPTION

ELECTRICAL:

- 1.VOLTAGE RATING :125 VAC RMS.
- 2.CURRENT RATING :1.5 AMP.
- 3.CONTACT RESISTANCE :30 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 50 V DC .
- 5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

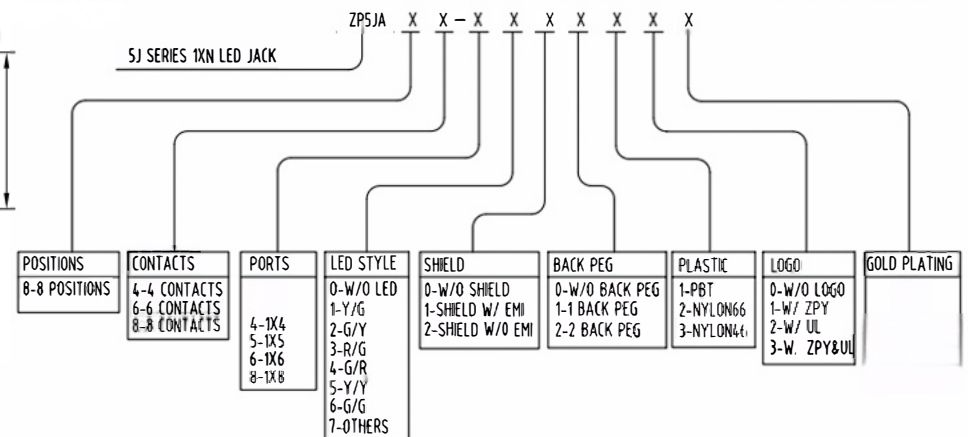
MECHANICAL:

- 1.DURRABILITY :750 CYCLES MIN.
- 2.PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C~+85°C
2. OPERATION : 0°C TO 70°C.

PART NUMBER:



MM (INCH) TOLERANCES EXCEPT AS NOTED MM 0.05 0.05 0.05 ANGLES 0.5 THIRD ANGLE PROJECTION	WTO SHB DATE 2007.05.05 CHKD LANBO ATE 2007.05.05 APPVL MATERIAL : QTY : FINISH SCALE :	浙江创都电子科技有限公司 TITLE RJ568P8C-DL-DT DRAWING NO. T.SJA1002 SIZE A3 REV 0 DO NOT SCALE DRAWING SHEET X OF Y